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ТΜ

FQB9N25 / FQI9N25 250V N-Channel MOSFET

General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supply.

Features

- + 9.4A, 250V, $R_{DS(on)}$ = 0.42 Ω @V_{GS} = 10 V + Low gate charge (typical 15.5 nC)
- Low Crss (typical 15 pF) •
- Fast switching
- · 100% avalanche tested
- · Improved dv/dt capability



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQB9N25 / FQI9N25	Units
V _{DSS}	Drain-Source Voltage		250	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		9.4	А
	- Continuous (T _C = 100°C))	5.9	А
I _{DM}	Drain Current - Pulsed	(Note 1)	37.6	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	165	mJ
I _{AR}	Avalanche Current	(Note 1)	9.4	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	9.0	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns
PD	Power Dissipation $(T_A = 25^{\circ}C)^{*}$		3.13	W
	Power Dissipation (T _C = 25°C)		90	W
	- Derate above 25°C	0.72	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.39	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		40	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W
* When mounter	ed on the minimum pad size recommended (PCB Mount)		·	

Symbol	Parameter	Test Conditions	i	Min	Тур	Max	Units
Off Cha	aracteristics						
BVnss	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA		250			V
ΔBV _{DSS}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced	to 25°C		0.2		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 250 V, V _{GS} = 0 V				1	μA
		V _{DS} = 200 V, T _C = 125°C	;			10	μA
GSSF	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V				100	nA
GSSR	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V				-100	nA
00		I					
		VV _ = 250 u A		2.0		5.0	V
GS(th)	State Threshold Voltage	V _{DS} - V _{GS} , I _D - 230 μA		3.0		5.0	V
∿DS(on)	On-Resistance	V _{GS} = 10 V, I _D = 4.7 A			0.33	0.42	Ω
JFS	Forward Transconductance	V _{DS} = 50 V, I _D = 4.7 A	(Note 4)	-	7.8		S
C _{rss}	Output Capacitance Reverse Transfer Capacitance	_ f = 1.0 MHz			110 15	145 20	p⊦ pF
C _{rss}	Reverse Transfer Capacitance				15	20	pF
Switchi	ing Characteristics						
d(on)	Turn-On Delay Time	V_{DD} = 125 V, I _D = 9.4 A, R _G = 25 Ω (Note 4, 5)			13	35	ns
r	Turn-On Rise Time				105	220	ns
d(off)	Turn-Off Delay Time				25	60	ns
f	Turn-Off Fall Time				45	100	ns
ე _g	Total Gate Charge	$V_{DS} = 200 \text{ V}, I_D = 9.4 \text{ A},$ $V_{CS} = 10 \text{ V}$			15.5	20	nC
Q _{gs}	Gate-Source Charge				3.8		nC
ຊ _{gd}	Gate-Drain Charge		(Note 4, 5)		8.5		nC
		d Marian Dation	_				
	Maximum Continuous Drain-Source Did	nd Maximum Ratings	5			0.1	۸
5	Maximum Continuous Drain-Source Diode Forward Current				37.6	Δ	
SM	Drain-Source Diode Forward Voltage	$V_{00} = 0 V I_0 = 9.4 \Delta$				1.5	V
'SD	Boverse Becovery Time	$V_{GS} = 0 V, I_S = 9.4 A$ $V_{GS} = 0 V, I_S = 9.4 A,$ $dI_c / dt = 100 A/\mu s$ (Note 4)			150	1.5	v ne
 D	Reverse Recovery Charge				0.8		пС
I I		1			0.0		μΟ

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